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Low Noise, High Throughput 24-Bit Sigma-Delta ADC

AD7731

FEATURES

24-Bit Sigma-Delta ADC
16 Bits p-p Resolution at 800 Hz Output Rate
Programmable Output Rates up to 6.4 kHz
Programmable Gain Front End
±0.0015% Nonlinearity
Buffered Differential Inputs
Programmable Filter Cutoffs
FASTStep™* Mode for Channel Sequencing
Single Supply Operation

APPLICATIONS
Process Control
PLCs/ DCS
Industrial Instrumentation

GENERAL DESCRIPTION

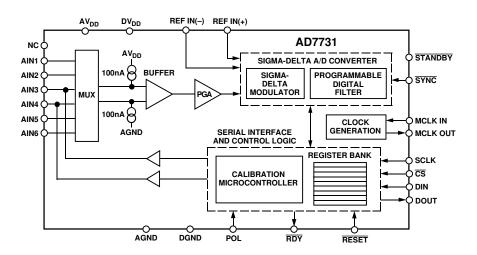
The AD7731 is a complete analog front-end for process control applications. The device has a proprietary programmable gain front end that allows it to accept a range of input signal ranges, including low level signals, directly from a transducer. The sigmadelta architecture of the part consists of an analog modulator and a low pass programmable digital filter, allowing adjustment of filter cutoff, output rate and settling time.

The part features three buffered differential programmable gain analog inputs (which can be configured as five pseudo-differential inputs), as well as a differential reference input. The part operates from a single +5 V supply and accepts seven unipolar analog input ranges: 0 to +20 mV, +40 mV, +80 mV, +160 mV, +320 mV, +640 mV and +1.28 V, and seven bipolar ranges: ±20 mV, ±40 mV, ±80 mV, ±160 mV, ±320 mV, ±640 mV and ±1.28 V. The peak-to-peak resolution achievable directly from the part is 16 bits at an 800 Hz output rate. The part can switch between channels with 1 ms settling time and maintain a performance level of 13 bits of peak-to-peak resolution.

The serial interface on the part can be configured for three-wire operation and is compatible with microcontrollers and digital signal processors. The AD7731 contains self-calibration and system calibration options and features an offset drift of less than 5 nV/°C and a gain drift of less than 2 ppm/°C.

The part is available in a 24-lead plastic DIP, a 24-lead SOIC and 24-lead TSSOP package.

FUNCTIONAL BLOCK DIAGRAM



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REV. A

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AD7731* PRODUCT PAGE QUICK LINKS

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COMPARABLE PARTS \Box

View a parametric search of comparable parts.

EVALUATION KITS

AD7731 Evaluation Kit

DOCUMENTATION

Application Notes

- AN-202: An IC Amplifier User's Guide to Decoupling, Grounding, and Making Things Go Right for a Change
- AN-283: Sigma-Delta ADCs and DACs
- AN-311: How to Reliably Protect CMOS Circuits Against Power Supply Overvoltaging
- AN-388: Using Sigma-Delta Converters-Part 1
- AN-389: Using Sigma-Delta Converters-Part 2
- AN-397: Electrically Induced Damage to Standard Linear Integrated Circuits:
- AN-607: Selecting a Low Bandwidth (<15 kSPS) Sigma-Delta ADC
- AN-615: Peak-to-Peak Resolution Versus Effective Resolution

Data Sheet

 AD7731: Low Noise, High Throughput 24-Bit Sigma-Delta ADC Data Sheet

TOOLS AND SIMULATIONS \Box

- · AD7730/AD7730L/AD7731 Digital Filter Model
- dt_Register_Assistant
- · Sigma-Delta ADC Tutorial

REFERENCE MATERIALS 🖳

Technical Articles

- Delta-Sigma Rocks RF, As ADC Designers Jump On Jitter
- MS-2210: Designing Power Supplies for High Speed ADC
- Part 1: Circuit Suggestions Using Features and Functionality of New Sigma-Delta ADCs
- Part 2: Circuit Suggestions Using Features and Functionality of New Sigma-Delta ADCs

DESIGN RESOURCES \Box

- · AD7731 Material Declaration
- PCN-PDN Information
- · Quality And Reliability
- · Symbols and Footprints

DISCUSSIONS

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DOCUMENT FEEDBACK 🖵

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Parameter	B Version ¹	Units	Conditions/Comments
STATIC PERFORMANCE (CHP = 0) No Missing Codes ²	24	Bits min	$SKIP = 0^3$
Output Noise and Update Rates ²	See Tables I and II	Dits iiiii	SKII = 0
Integral Nonlinearity	15	ppm of FSR max	
Offset Error ²	See Note 4	ppin of rak max	Offset Error and Offset Drift Refer to Both
Offset Drift vs. Temperature ²	0.5	uV/°C typ	Input Range = 20 mV , 40 mV , 80 mV , 160 mV
Offset Difft vs. Temperature		μV/°C typ	
Office Deift on Time 5	1/2/5	μV/°C typ	Input Range = 320 mV/640 mV/1.28 V
Offset Drift vs. Time ⁵ Positive Full-Scale Error ^{2, 6}	2.5	μV/1000 Hr	
	See Note 4		I D 20 V 40 V 90 V 160 V
Positive Full-Scale Drift vs. Temp ^{2, 7, 8}	0.6	μV/°C typ	Input Range = 20 mV , 40 mV , 80 mV , 160 mV
5	1.5/3/6	μV/°C typ	Input Range = $320 \text{ mV}/640 \text{ mV}/1.28 \text{ V}$
Positive Full-Scale Drift vs. Time ⁵	3	μV/1000 Hr	
Gain Error ^{2, 9}	See Note 4		
Gain Drift vs. Temperature ^{2, 7, 10}	2	ppm/°C typ	
Gain Drift vs. Time ⁵	10	ppm/1000 Hr	
Bipolar Negative Full-Scale Error ²	See Note 4		
Negative Full-Scale Drift vs. Temp ^{2, 7}	1	μV/°C typ	
Power Supply Rejection ¹¹	90	dB typ	Input Range = 20 mV
Power Supply Rejection ¹¹	60	dB typ	Input Range = 1.28 V
Common-Mode Rejection (CMR) ¹¹			
On AIN	95	dB typ	At DC. Input Range = 20 mV
On AIN	85	dB typ	At DC. Input Range = 1.28 V
On REF IN	120	dB typ	
Analog Input DC Bias Current ²	60	nA max	
Analog Input DC Bias Current Drift ²	150	pA/°C typ	
Analog Input DC Offset Current ²	30	nA max	
Analog Input DC Offset Current Drift ²	100	pA/°C typ	
Analog input De Onset Current Dint	100	pro C typ	
STATIC PERFORMANCE $(CHP = 1)^2$			
No Missing Codes	24	Bits min	
Output Noise and Update Rates	See Tables III and IV		
Integral Nonlinearity	15	ppm of FSR max	
Offset Error	See Note 4	ppin of Fort man	Offset Error and Offset Drift Refer to Both
Offset Drift vs. Temperature	5	nV/°C typ	Unipolar Offset and Bipolar Zero Errors
Offset Drift vs. Time ⁵	25	nV/1000 Hr typ	Chipolai Offset and Dipolai Zero Effors
Positive Full-Scale Error ⁶	See Note 4	n v/1000 iii typ	
Positive Full-Scale Drift vs. Temp ^{7, 8}	2	ppm of FS/°C max	
Positive Full-Scale Drift vs. Temp ⁵	$\begin{vmatrix} 2 \\ 10 \end{vmatrix}$		
Gain Error ⁹		ppm of FS/1000 Hr	
	See Note 4	100	
Gain Drift vs. Temperature ^{7, 10}	2	ppm/°C max	
Gain Drift vs. Time ⁵	10	ppm/1000 Hr	
Bipolar Negative Full-Scale Error	See Note 4		
Negative Full-Scale Drift vs. Temp	2	ppm of FS/°C max	
Power Supply Rejection ¹¹	110	dB typ	Input Range = 20 mV
Power Supply Rejection ¹¹	85	dB typ	Input Range = 1.28 V
Common-Mode Rejection (CMR) ¹¹			
On AIN	110	dB typ	At DC. Input Range = 20 mV
On AIN	85	dB typ	At DC. Input Range = 1.28 V
On REF IN	120	dB typ	
Analog Input DC Bias Current	50	nA max	
Analog Input DC Bias Current Drift	100	pA/°C typ	
Analog Input DC Offset Current	10	nA max	
Analog Input DC Offset Current Drift	50	pA/°C typ	
- Imaiog input 2 c o inset current 2 int		Pra c typ	
ANALOG INPUTS/REFERENCE INPUTS			
Normal Mode 50 Hz/60 Hz Rejection ²	88	dB min	$50 \text{ Hz}/60 \text{ Hz} \pm 1 \text{ Hz}$. SKIP = 0
Common-Mode 50 Hz/60 Hz Rejection ²	120	dB min	$50 \text{ Hz}/60 \text{ Hz} \pm 1 \text{ Hz}$. SKIP = 0
Analog Inputs			
Differential Input Voltage Ranges ¹²			Assuming 2.5 V or 5 V Reference with HIREF
Differential input voltage ranges			Bit Set Appropriately
	0 to +20 or ± 20	mV nom	RN2, RN1, RN0 of Mode Register = 0, 0, 1
	0 to +20 or ± 20 0 to +40 or ± 40	mV nom	RN2, RN1, RN0 of Mode Register = 0 , 0 , 1
	0 to +80 or ±80	mV nom	RN2, RN1, RN0 of Mode Register = 0 , 1, 0 RN2, RN1, RN0 of Mode Register = 0 , 1, 1
	0 to $+80$ or ± 80 0 to $+160$ or ± 160	mV nom	
			RN2, RN1, RN0 of Mode Register = 1, 0, 0
	0 to $+320$ or ± 320	mV nom	RN2, RN1, RN0 of Mode Register = 1, 0, 1
	0 to +640 or ± 640	mV nom	RN2, RN1, RN0 of Mode Register = 1, 1, 0
	0 to ± 1.28 or ± 1.28	V nom	RN2, RN1, RN0 of Mode Register = 1 , 1 , 1

–2– REV. A

Parameter	B Version ¹	Units	Conditions/Comments
Absolute/Common-Mode Voltage ¹³	AGND + 1.2 V	V min	
D.C. I.	$AV_{DD} - 0.95 V$	V max	
Reference Input	.2.5	V	HIDEE Dit of Mode Desister 0
REF IN(+) – REF IN (-) Voltage REF IN(+) – REF IN (-) Voltage	+2.5 +5	V nom V nom	HIREF Bit of Mode Register = 0 HIREF Bit of Mode Register = 1
Reference DC Input Current	5.5	μA max	HIREF Bit of Mode Register = 1 HIREF Bit of Mode Register = 0
Reference DC Input Current	10	μA max	HIREF Bit of Mode Register = 1
Absolute/Common-Mode Voltage ¹⁴	AGND – 30 mV	V min	TIRE Bit of Mode Register - 1
riosome, common prode vonage	$AV_{DD} + 30 \text{ mV}$	V max	
NO REF Trigger Voltage	0.3	V min	NO REF Bit Active If VREF Below This Voltage
	0.65	V max	NO REF Bit Inactive If VREF Above This Voltage
LOGIC INPUTS			
Input Current	±10	μA max	
All Inputs Except SCLK and MCLK IN			
V _{INL} , Input Low Voltage	0.8	V max	$DV_{DD} = +5 V$
V _{INL} , Input Low Voltage	0.4	V max	$DV_{DD} = +3 V$
V _{INH} , Input High Voltage	2.0	V min	
SCLK Only (Schmitt Triggered Input)			
V_{T+}	1.4/3	V min/V max	$DV_{DD} = +5 V$
V_{T+}	0.95/2.5	V min/V max	$DV_{DD} = +3 V$
V_{T-}	0.8/1.4	V min/V max	$DV_{DD} = +5 V$
V_{T-}	0.4/1.1	V min/V max	$DV_{DD} = +3 V$
$V_{T+} - V_{T-}$	0.4/0.85	V min/V max	$DV_{DD} = +5 V$
$V_{T+} - V_{T-}$	0.4/0.8	V min/V max	$DV_{DD} = +3 V$
MCLK IN Only	0.0	V	DV .5V
V _{INL} , Input Low Voltage	0.8	V max	$DV_{DD} = +5 V$
V _{INL} , Input Low Voltage	0.4	V max V min	$DV_{DD} = +3 V$ $DV_{DD} = +5 V$
V _{INH} , Input High Voltage	3.5 2.5		$DV_{DD} = +5 V$ $DV_{DD} = +2 V$
V _{INH} , Input High Voltage	2.3	V min	$DV_{DD} = +3 V$
LOGIC OUTPUTS (Including MCLK OUT)			
V _{OL} , Output Low Voltage	0.4	V max	$I_{SINK} = 800 \mu A Except for MCLK OUT^{15}$.
			$V_{\rm DD}^{16} = +5 \text{ V}$
V _{OL} , Output Low Voltage	0.4	V max	$I_{SINK} = 100 \mu A Except for MCLK OUT^{15}$.
			$V_{\rm DD}^{16} = +3 \text{ V}$
V _{OH} , Output High Voltage	4.0	V min	$I_{\text{SOURCE}} = 200 \mu\text{A}$ Except for MCLK OUT 15.
VOH, Output High Voltage	$DV_{DD} - 0.6 V$	V min	V_{DD}^{16} = +5 V I_{SOURCE} = 100 μ A Except for MCLK OUT ¹⁵ .
V _{OH} , Output High Voltage	$D V_{DD} = 0.0 V$	V IIIIII	$V_{DD}^{16} = +3 \text{ V}$
Floating State Leakage Current	±10	μA max	VDD - +3 V
Floating State Output Capacitance ³	6	pF typ	
		Pr tJP	
TRANSDUCER BURNOUT 17			
AIN1(+) Current	-100	nA nom	
AIN 1(-) Current	100	nA nom	
Initial Tolerance @ 25°C	±10	% typ	
Drift	0.1	%/°C typ	
SYSTEM CALIBRATION			
Positive Full-Scale Calibration Limit ¹⁸	$1.05 \times FS$	V max	FS Is the Nominal Full-Scale Voltage (20 mV,
			40 mV, 80 mV, 160 mV, 320 mV, 640 mV, 1.28 V)
Negative Full-Scale Calibration Limit ¹⁸	$-1.05 \times FS$	V max	
Offset Calibration Limit ¹⁹	$-1.05 \times FS$	V min	
Input Span ¹⁹	$0.8 \times FS$	V min	
	$2.1 \times FS$	V max	
POWER REQUIREMENTS			
Power Supply Voltages			
AV _{DD} – AGND Voltage	+5	V nom	
DV _{DD} Voltage	+2.7 to +5.25	V min to V max	With $AGND = 0 V$
Power Supply Currents			External MCLK. Digital I/Ps = 0 V or DV _{DD}
AV _{DD} Current (Normal Mode)	10.3	mA max	
DV _{DD} Current (Normal Mode)	1.7	mA max	DV _{DD} of 2.7 V to 3.3 V
DV _{DD} Current (Normal Mode)	3.2	mA max	DV _{DD} of 4.75 V to 5.25 V
$AV_{DD} + DV_{DD}$ Current (Standby Mode)	25	μA max	Typically 10 μ A. External MCLK IN = 0 V or DV _{DD}
Power Dissipation			$AV_{DD} = DV_{DD} = +5 \text{ V. Digital I/Ps} = 0 \text{ V or } DV_{DD}$
Normal Mode	67.5	mW max	
Standby Mode	125	μW max	Typically 50 μ W. External MCLK IN = 0 V or DV _{DD}

REV. A -3-

- Temperature Range: -40°C to +85°C.
- ² Sample tested during initial release.
- ³ No missing codes performance with CHP = 0 and SKIP = 1 is 22 bits.
- ⁴ The offset (or zero) numbers with CHP = 0 can be up to 1 mV precalibration. Internal zero-scale calibration reduces this to 2 μV typical. Offset numbers with CHP = 1 are typically 3 µV precalibration. Internal zero-scale calibration reduces this by about 1 µV. System zero-scale calibration reduces offset numbers with CHP = 0 and CHP = 1 to the order of the noise. Gain errors can be up to 3000 ppm precalibration with CHP = 0 and CHP = 1. Performing internal full-scale calibrations on all input ranges except the 20 mV and 40 mV input range reduces the gain error to less than 100 ppm. When operating on the 20 mV or 40 mV range, an internal full-scale calibration should be performed on the 80 mV input range with a resulting gain error of less than 250 ppm. System full-scale calibration reduces the gain error on all input ranges to the order of the noise. Positive and Negative Full-Scale Errors can be calculated from the offset and gain errors.
- ⁵ These numbers are generated during life testing of the part.
- ⁶ Positive Full-Scale Error includes Zero-Scale Errors (Unipolar Offset Error or Bipolar Zero Error) and applies to both unipolar and bipolar input ranges. See Terminology.
- ⁷ Recalibration at any temperature will remove these errors.
- 8 Full-scale drift includes Zero-Scale Drift (Unipolar Offset Drift or Bipolar Zero Drift) and applies to both unipolar and bipolar input ranges.
- ⁹ Gain Error is a measure of the difference between the measured and the ideal span between any two points in the transfer function. The two points use to calculate the gain error are positive full-scale and negative full-scale. See Terminology.
- ¹⁰ Gain Error Drift is a span drift and is effectively the drift of the part if zero-scale calibrations only were performed.
- 11 Power Supply Rejection and Common-Mode Rejection are given here for the upper and lower input voltage ranges. The rejection can be approximated to varying linearly (in dBs) between these values for the other input ranges.
- The analog input voltage range on the AIN(+) inputs is given here with respect to the voltage on the respective AIN(-) input.
- 13 The common-mode voltage range on the input pairs applies provided the absolute input voltage specification is obeyed.

 14 The common-mode voltage range on the reference input pair (REF IN(+) and REF IN(-)) applies provided the absolute input voltage specification is obeyed.
- 15 These logic output levels apply to the MCLK OUT output only when it is loaded with a single CMOS load.
- ¹⁶ V_{DD} refers to DV_{DD} for all logic outputs expect D0 and D1 where it refers to AV_{DD}. In other words, the output logic high for these two outputs is determined by AV_{DD}.
- ¹⁷ See Burnout Current section.
- 18 After calibration, if the input voltage exceeds positive full scale, the converter will output all 1s. If the input is less than negative full scale, then the device outputs all 0s.
- These calibration and span limits apply provided the absolute input voltage specification is obeyed. The offset calibration limit applies to both the unipolar zero point and the bipolar zero point.

Specifications subject to change without notice.

TIMING CHARACTERISTICS¹, 2 (AV_{DD} = +4.75 V to +5.25 V; DV_{DD} = +2.7 V to +5.25 V; AGND = DGND = 0 V; f_{CLKIN} = 4.9152 MHz; Input Logic 0 = 0 V, Logic 1 = DV_{DD} unless otherwise noted)

Parameter	Limit at T _{MIN} , T _{MAX} (B Version)	Units	Conditions/Comments
Master Clock Range	1	MHz min	For Specified Performance
	5	MHz max	-
t_1	50	ns min	SYNC Pulse Width
t_2	50	ns min	RESET Pulse Width
Read Operation			
t_3	0	ns min	RDY to CS Setup Time
t_4	0	ns min	CS Falling Edge to SCLK Active Edge Setup Time ³
t_4 t_5	0	ns min	SCLK Active Edge to Data Valid Delay ³
	60	ns max	$DV_{DD} = +4.75 \text{ V to } +5.25 \text{ V}$
	80	ns max	$DV_{DD} = +2.7 \text{ V to } +3.3 \text{ V}$
$t_{5A}^{4, 5}$	0	ns min	CS Falling Edge to Data Valid Delay ³
	60	ns max	$DV_{DD} = +4.75 \text{ V to } +5.25 \text{ V}$
	80	ns max	$DV_{DD} = +2.7 \text{ V to } +3.3 \text{ V}$
t_6	100	ns min	SCLK High Pulse Width
t ₇	100	ns min	SCLK Low Pulse Width
t_8	0	ns min	CS Rising Edge to SCLK Inactive Edge Hold Time ³
t_8 t_9	10	ns min	Bus Relinquish Time after SCLK Inactive Edge ³
	80	ns max	
t ₁₀	100	ns max	SCLK Active Edge to RDY High ^{3,7}
Write Operation			
t ₁₁	0	ns min	CS Falling Edge to SCLK Active Edge Setup Time ³
t ₁₂	30	ns min	Data Valid to SCLK Edge Setup Time
t ₁₃	25	ns min	Data Valid to SCLK Edge Hold Time
t ₁₄	100	ns min	SCLK High Pulse Width
t ₁₅	100	ns min	SCLK Low Pulse Width
t ₁₆	0	ns min	CS Rising Edge to SCLK Edge Hold Time

NOTES

- Sample tested during initial release to ensure compliance. All input signals are specified with tr = tf = 5 ns (10% to 90% of DV_{DD}) and timed from a voltage level of 1.6 V.
- ² See Figures 15 and 16.
- ³ SCLK active edge is falling edge of SCLK with POL = 1; SCLK active edge is rising edge of SCLK with POL = 0.
- ⁴ These numbers are measured with the load circuit of Figure 1 and defined as the time required for the output to cross the V_{OL} or V_{OH} limits.
- ⁵ This specification only comes into play if \overline{CS} goes low while SCLK is low (POL = 1) or if \overline{CS} goes low while SCLK is high (POL = 0). It is required primarily for interfacing to
- ⁶ These numbers are derived from the measured time taken by the data output to change 0.5 V when loaded with the circuit of Figure 1. The measured number is then extrapolated back to remove effects of charging or discharging the 50 pF capacitor. This means that the times quoted in the timing characteristics are the true bus relinquish times of the part and as such are independent of external bus loading capacitances.
- 7 RDY returns high after the first read from the device after an output update. The same data can be read again, if required, while RDY is high, although care should be taken that subsequent reads do not occur close to the next output update.

REV. A _4_

ABSOLUTE MAXIMUM RATINGS*

$(T_A = +25^{\circ}C \text{ unless otherwise noted})$	
AVDD to AGND0.3 V	to +7 V
AVDD to DGND0.3 V	to +7 V
DVDD to AGND0.3 V	to +7 V
DVDD to DGND0.3 V	to +7 V
AGND to DGND5 V to	o +0.3 V
AVDD to DVDD2 V	to +5 V
Analog Input Voltage to AGND0.3 V to AVDE	0.3 V
Reference Input Voltage to AGND0.3 V to AVDD	+0.3 V
AIN/REF IN Current (Indefinite)	
	30 mA
AIN/REF IN Current (Indefinite)	30 mA > + 0.3 V
AIN/REF IN Current (Indefinite)	30 mA 0 + 0.3 V 0 + 0.3 V
AIN/REF IN Current (Indefinite)	30 mA 0 + 0.3 V 0 + 0.3 V
AIN/REF IN Current (Indefinite)	30 mA 0 + 0.3 V 0 + 0.3 V 0 + 0.3 V
AIN/REF IN Current (Indefinite) Digital Input Voltage to DGND0.3 V to DVDD Digital Output Voltage to DGND0.3 V to DVDD Output Voltage (D0, D1) to DGND0.3 V to AVDD Operating Temperature Range Industrial (B Version)40°C to	30 mA 0 + 0.3 V 0 + 0.3 V 0 + 0.3 V 0 + 85°C
AIN/REF IN Current (Indefinite)	30 mA 0+0.3 V 0+0.3 V 0+0.3 V 0+85°C +150°C

Plastic DIP Package, Power Dissipation	450 mW
θJA Thermal Impedance	105°C/W
Lead Temperature (Soldering, 10 sec)	+260°C
TSSOP Package, Power Dissipation	
θ _{JA} Thermal Impedance	128°C/W
Lead Temperature, Soldering	
Vapor Phase (60 sec)	+215°C
Infrared (15 sec)	+220°C
SOIC Package, Power Dissipation	450 mW
θJA Thermal Impedance	75°C/W
Lead Temperature, Soldering	
Vapor Phase (60 sec)	+215°C
Infrared (15 sec)	+220°C
*Stresses above those listed under Absolute Maximum Ratings ma	•
permanent damage to the device. This is a stress rating only; functi	
operation of the device at these or any other conditions above those operational sections of this specification is not implied. Exposure to	
maximum rating conditions for extended periods may affect device	
manifest rating conditions for extended periods may direct device	

ORDERING GUIDE

Model (Z = RoHS)	Temperature Range	Package Description	Package Option	RoHS Compliant
AD7731BN	-40°C to +85°C	24-Lead PDIP	N-24-1	No
AD7731BNZ	-40°C to +85°C	24-Lead PDIP	N-24-1	Yes
AD7731BR	-40°C to +85°C	24-Lead SOIC_W	RW-24	No
AD7731BR-REEL	-40°C to +85°C	24-Lead SOIC_W	RW-24	No
AD7731BR-REEL7	-40°C to +85°C	24-Lead SOIC_W	RW-24	No
AD7731BRZ	−40°C to +85°C	24-Lead SOIC_W	RW-24	Yes
AD7731BRZ-REEL	-40°C to +85°C	24-Lead SOIC_W	RW-24	Yes
AD7731BRZ-REEL7	-40°C to +85°C	24-Lead SOIC_W	RW-24	Yes
AD7731BRU	−40°C to +85°C	24-Lead TSSOP	RU-24	No
AD7731BRU-REEL	-40°C to +85°C	24-Lead TSSOP	RU-24	No
AD7731BRU-REEL7	-40°C to +85°C	24-Lead TSSOP	RU-24	No
AD7731BRUZ	-40°C to +85°C	24-Lead TSSOP	RU-24	Yes
AD7731BRUZ-REEL	-40°C to +85°C	24-Lead TSSOP	RU-24	Yes
AD7731BRUZ-REEL7	-40°C to +85°C	24-Lead TSSOP	RU-24	Yes
EVAL-AD7731EBZ		Evaluation Board		Yes

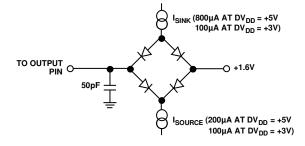


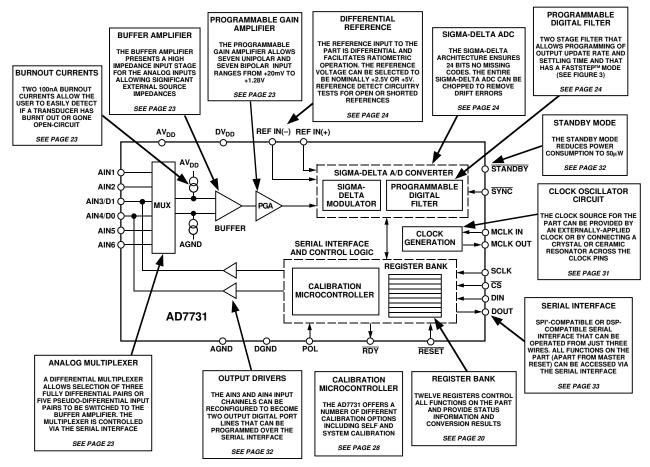
Figure 1. Load Circuit for Access Time and Bus Relinquish Time

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



REV. A -5-



*SPI IS A TRADEMARK OF MOTOROLA, INC.

Figure 2. Detailed Functional Block Diagram

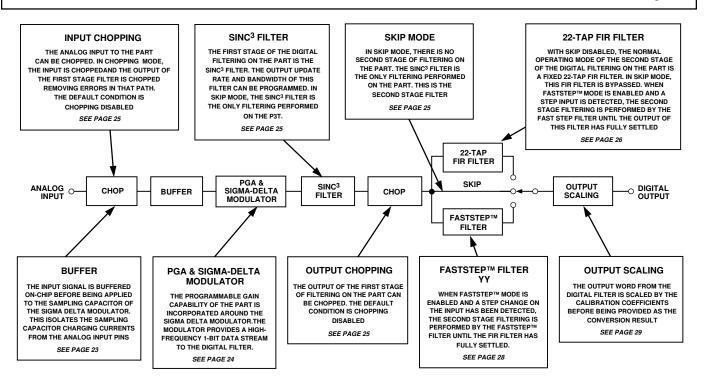
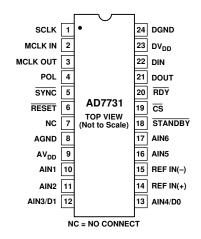


Figure 3. Signal Processing Chain

PIN CONFIGURATION



PIN FUNCTION DESCRIPTIONS

Pin No.	Pin Mnemonic	Function
1	SCLK	Serial Clock. Schmitt-Triggered Logic Input. An external serial clock is applied to this input to transfer serial data to or from the AD7731. This serial clock can be a continuous clock with all data transmitted in a continuous train of pulses. Alternatively, it can be a noncontinuous clock with the information being transmitted to or from the AD7731 in smaller batches of data.
2	MCLK IN	Master Clock signal for the device. This can be provided in the form of a crystal/resonator or external clock. A crystal/resonator can be tied across the MCLK IN and MCLK OUT pins. Alternatively, the MCLK IN pin can be driven with a CMOS-compatible clock and MCLK OUT left unconnected. The part is specified with a clock input frequency of 4.9152 MHz.

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PIN FUNCTION DESCRIPTIONS (Continued)

Pin No.	Pin Mnemonic	Function
3	MCLK OUT	When the master clock for the device is a crystal/resonator, the crystal/resonator is connected between MCLK IN and MCLK OUT. If an external clock is applied to the MCLK IN, MCLK OUT provides an inverted clock signal. This clock can be used to provide a clock source for external circuits and MCLK OUT is capable of driving one CMOS load.
4	POL	Clock Polarity. Logic Input. This determines the polarity of the serial clock. If the active edge for the processor is a high-to-low SCLK transition, this input should be low. In this mode, the AD7731 puts out data on the DATA OUT line in a read operation on a low-to-high transition of SCLK and clocks in data from the DATA IN line in a write operation on a high-to-low transition of SCLK. In applications with a noncontinuous serial clock (such as most microcontroller applications), this means that the serial clock should idle low between data transfers. If the active edge for the processor is a low-to-high SCLK transition, this input should be high. In this mode, the AD7731 puts out data on the DATA OUT line in a read operation on a high-to-low transition of SCLK and clocks in data from the DATA IN line in a write operation on a low-to-high transition of SCLK. In applications with a noncontinuous serial clock (such as most microcontroller applications), this means that the serial clock should idle high between data transfers.
5	SYNC	Logic Input that allows for synchronization of the digital filters and analog modulators when using a number of AD7731s. While <u>SYNC</u> is low, the nodes of the digital filter, the filter control logic and the calibration control logic are reset and the analog modulator is also held in its reset state. <u>SYNC</u> does not affect the digital interface but does reset <u>RDY</u> to a high state if it is low. While <u>SYNC</u> is asserted, the Mode Bits may be set up for a subsequent operation that will commence when the <u>SYNC</u> pin is deasserted.
6	RESET	Logic Input. Active low input that resets the control logic, interface logic, digital filter, analog modulator and all on-chip registers of the part to power-on status. Effectively, everything on the part except for the clock oscillator is reset when the RESET pin is exercised.
7	NC	No Connect. The user is advised not to connect anything to this pin.
8	AGND	Ground reference point for analog circuitry.
9	AV_{DD}	Analog Positive Supply Voltage. The AV _{DD} to AGND differential is 5 V nominal.
10	AIN1	Analog Input Channel 1. Programmable-gain analog input that can be used as a pseudo-differential input when used with AIN6 or as the positive input of a differential pair when used with AIN2.
11	AIN2	Analog Input Channel 2. Programmable-gain analog input that can be used as a pseudo-differential input when used with AIN6 or as the negative input of a differential pair when used with AIN1.
12	AIN 3/D1	Analog Input Channel 3 or Digital Output 1. This pin can be used as either an analog input or a digital output bit as determined by the DEN bit of the Mode Register. When selected as a programmable-gain analog input, it can be used as a pseudo-differential input when used with AIN6 or as the positive input of a differential pair when used with AIN4. When selected as a digital output, this output can be programmed over the serial interface using bit D1 of the Mode Register.
13	AIN4/D0	Analog Input Channel 4 or Digital Output 0. This pin can be used as either an analog input or a digital output bit as determined by the DEN bit of the Mode Register. When selected as a programmable-gain analog input, it can be used as a pseudo-differential input when used with AIN6 or as the negative input of a differential pair when used with AIN3. When selected as a digital output, this output can be programmed over the serial interface using bit D0 of the Mode Register.
14	REF IN(+)	Reference Input. Positive terminal of the differential reference input to the AD7731. REF IN(+) can lie anywhere between AV_{DD} and $AGND$. The nominal reference voltage (i.e., the differential voltage between REF IN(+) and REF IN(-)) should be +2.5 V when the HIREF bit of the Mode Register is 0 and is +5 V when the HIREF bit of the Mode Register is 1.
15	REF IN(-)	Reference Input. Negative terminal of the differential reference input to the AD7731. The REF IN(-) can lie anywhere between AV _{DD} and AGND.
16	AIN5	Analog Input Channel 5. Programmable-gain analog input which can be used is the positive input of a differential pair when used with AIN6.
17	AIN6	Analog Input Channel 6. Reference point for AIN1 through AIN4 in pseudo-differential mode or as the negative input of a differential input pair when used with AIN5.
18	STANDBY	Logic Input. Taking this pin low shuts down the analog and digital circuitry, reducing current consumption to the 10 µA range. The on-chip registers retain all their values when the part is in standby mode.
19	CS	Chip Select. Active low Logic Input used to select the AD7731. With this input hardwired low, the AD7731 can operate in its three-wire interface mode with SCLK, DIN and DOUT used to interface to the device. \overline{CS} can be used to select the device in systems with more than one device on the serial bus or as a frame synchronization signal in communicating with the AD7731.

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PIN FUNCTION DESCRIPTIONS (Continued)

Pin	Pin	
No.	Mnemonic	Function
20	RDY	Logic output. Used as a status output in both conversion mode and calibration mode. In conversion mode, a logic low on this output indicates that a new output word is available from the AD7731 data register. The RDY pin will return high upon completion of a read operation of a full output word. If no data read has taken place after an output update, the RDY line will return high prior to the next output update, remain high while the update is taking place and return low again. This gives an indication of when a read operation should not be initiated to avoid initiating a read from the data register as it is being updated. In calibration mode, RDY goes high when calibration is initiated and returns low to indicate that calibration is complete. A number of different events on the AD7731 set the RDY high and these are outlined in Table XVII.
21	DOUT	Serial Data Output with serial data being read from the output shift register on the part. This output shift register can contain information from the calibration registers, mode register, status register, filter register or data register depending on the register selection bits of the Communications Register.
22	DIN	Serial Data Input with serial data being written to the input shift register on the part. Data from this input shift register is transferred to the calibration registers, mode register, communications register or filter register depending on the register selection bits of the Communications Register.
23	DV_{DD}	Digital Supply Voltage, +3 V or +5 V nominal.
24	DGND	Ground reference point for digital circuitry.

TERMINOLOGY INTEGRAL NONLINEARITY

This is the maximum deviation of any code from a straight line passing through the endpoints of the transfer function. The endpoints of the transfer function are zero scale (not to be confused with bipolar zero), a point 0.5 LSB below the first code transition (000...000 to 000...001) and full scale, a point 0.5 LSB above the last code transition (111...110 to 111...111). The error is expressed as a percentage of full scale.

POSITIVE FULL-SCALE ERROR

Positive Full-Scale Error is the deviation of the last code transition (111...110 to 111...111) from the ideal AIN(+) voltage (AIN(-) + V_{REF}/G AIN - 3/2 LSBs). It applies to both unipolar and bipolar analog input ranges.

UNIPOLAR OFFSET ERROR

Unipolar Offset Error is the deviation of the first code transition from the ideal AIN(+) voltage (AIN(-) + 0.5 LSB) when operating in the unipolar mode.

BIPOLAR ZERO ERROR

This is the deviation of the midscale transition (0111...111 to 1000...000) from the ideal AIN(+) voltage (AIN(-) – 0.5 LSB) when operating in the bipolar mode.

GAIN ERROR

This is a measure of the span error of the ADC. It is a measure of the difference between the measured and the ideal span between any two points in the transfer function. The two points used to calculate the gain error are positive full scale and negative full scale.

BIPOLAR NEGATIVE FULL-SCALE ERROR

This is the deviation of the first code transition from the ideal AIN(+) voltage (AIN(-) – $V_{REF}/GAIN$ + 0.5 LSB) when operating in the bipolar mode. Negative full-scale error is a summation of zero error and gain error.

POSITIVE FULL-SCALE OVERRANGE

Positive Full-Scale Overrange is the amount of overhead available to handle input voltages on AIN(+) input greater than AIN(-) + V_{REF}/G AIN (for example, noise peaks or excess voltages due to system gain errors in system calibration routines) without introducing errors due to overloading the analog modulator or overflowing the digital filter.

NEGATIVE FULL-SCALE OVERRANGE

This is the amount of overhead available to handle voltages on AIN(+) below $AIN(-) - V_{REF}/GAIN$ without overloading the analog modulator or overflowing the digital filter.

OFFSET CALIBRATION RANGE

In the system calibration modes, the AD7731 calibrates its offset with respect to the analog input. The Offset Calibration Range specification defines the range of voltages the AD7731 can accept and still accurately calibrate offset.

FULL-SCALE CALIBRATION RANGE

This is the range of voltages that the AD7731 can accept in the system calibration mode and still accurately calibrate full scale.

INPUT SPAN

In system calibration schemes, two voltages applied in sequence to the AD7731's analog input define the analog input range. The input span specification defines the minimum and maximum input voltages from zero to full scale that the AD7731 can accept and still accurately calibrate gain.

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OUTPUT NOISE AND RESOLUTION SPECIFICATION

The AD7731 has a number of different modes of operation of the on-chip filter and chopping features. These options are discussed in more detail in later sections. The part can be programmed either to optimize the throughput rate and settling time or to optimize noise and drift performance. Noise tables for two of the primary modes of operation of the part are outlined below for a selection of output rates and settling times. The first mode, where the AD7731 is configured with CHP = 0 and SKIP mode enabled, provides fast settling time while still maintaining high resolution. The second mode, where CHP = 1 and the full second filter is included, provides very low noise numbers with lower output rates. Settling time refers to the time taken to get an output that is 100% settled to the new value after a channel change or exercising $\overline{\text{SYNC}}$.

Output Noise (CHP = 0, SKIP = 1)

Table I shows the output rms noise for some typical output update rates and -3 dB frequencies for the AD7731 when used in nonchop mode (CHP of Filter Register = 0) and with the second filter bypassed (SKIP of Filter Register = 1). The table is generated with a master clock frequency of 4.9152 MHz. These numbers are typical and generated at a differential analog input voltage of 0 V. The output update rate is selected via the SF0 to SF11 bits of the Filter Register. Table II, meanwhile, shows the output peak-to-peak resolution in bits (rounded to the nearest 0.5 LSB) for the same output update rates. It is important to note that the numbers in Table II represent the resolution for which there will be no code flicker within a six-sigma limit. They are not calculated based on rms noise but on peak-to-peak noise.

The numbers are generated for the bipolar input ranges. When the part is operated in unipolar mode, the output noise will be the same as the equivalent bipolar input range. As a result, the numbers in Table I will remain the same for unipolar ranges. To calculate the numbers for Table II for unipolar input ranges simply subtract one from the peak-to-peak resolution number in bits.

Table I. Output Noise vs. Input Range and Update Rate (CHP = 0, SKIP = 1) Typical Output RMS Noise in μV

Output	-3 dB	SF	Settling				Input Range	;		
Data Rate	Frequency	Word	Time	±1.28 V	±640 m V	±320 mV	±160 m V	±80 m V	±40 m V	±20 mV
150 Hz	39.3 Hz	2048	20 ms	2.6	1.45	0.87	0.6	0.43	0.28	0.2
200 Hz	52.4 Hz	1536	15 ms	3.0	1.66	1.02	0.69	0.48	0.32	0.22
300 Hz	78.6 Hz	1024	10 ms	3.7	2	1.26	0.84	0.58	0.41	0.28
400 Hz	104.8 Hz	768	7.5 ms	4.2	2.3	1.46	1.0	0.69	0.46	0.32
600 Hz	157 Hz	512	5 ms	5.2	2.9	1.78	1.2	0.85	0.58	0.41
800 Hz	209.6 Hz	384	3.75 ms	6	3.3	2.1	1.4	0.98	0.66	0.47
1200 Hz	314 Hz	256	2.5 ms	7.8	4.3	2.6	1.8	1.27	0.82	0.57
1600 Hz	419.2 Hz	192	1.87 ms	10.9	5.4	3.5	2.18	1.51	0.94	0.64
2400 Hz	629 Hz	128	1.25 ms	27.1	13.9	7.3	3.5	2.22	1.24	0.83
3200 Hz	838.4 Hz	96	0.94 ms	47	24.4	11.4	5.3	3.1	1.9	1.0
4800 Hz	1260 Hz	64	0.625 ms	99	50.3	24.5	12.5	6.5	3.3	1.7
6400 Hz	1676 Hz	48	0.47 ms	193	97	48	24	11.8	6.6	3.0

Table II. Peak-to-Peak Resolution vs. Input Range and Update Rate (CHP = 0, SKIP = 1)

Peak-to-Peak Resolution in Bits

Output	-3 dB	SF	Settling				Input Range	e		
Data Rate	Frequency	Word	Time	±1.28 V	±640 mV	±320 mV	±160 mV	±80 mV	±40 m V	±20 mV
150 Hz	39.3 Hz	2048	20 ms	17.5	17	17	16.5	16	15.5	15
200 Hz	52.4 Hz	1536	15 ms	17	17	16.5	16.5	16	15.5	15
300 Hz	78.6 Hz	1024	10 ms	17	16.5	16.5	16	15.5	15	14.5
400 Hz	104.8 Hz	768	7.5 ms	16.5	16.5	16	15.5	15.5	15	14.5
600 Hz	157 Hz	512	5 ms	16.5	16	16	15.5	15	14.5	14
800 Hz	209.6 Hz	384	3.75 ms	16	16	15.5	15	14.5	14.5	14
1200 Hz	314 Hz	256	2.5 ms	15.5	15.5	15.5	15	14.5	14	13.5
1600 Hz	419.2 Hz	192	1.87 ms	15	15.5	15	14.5	14	14	13.5
2400 Hz	629 Hz	128	1.25 ms	14	14	14	14	13.5	13.5	13
3200 Hz	838.4 Hz	96	0.94 ms	13	13	13	13	13	13	12.5
4800 Hz	1260 Hz	64	0.625 ms	12	12	12	12	12	11.5	12
6400 Hz	1676 Hz	48	0.47 ms	11	11	11	11	11	11	11

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Output Noise (CHP = 1, SKIP = 0)

Table III shows the output rms noise for some typical output update rates and -3 dB frequencies for the AD7731 when used in chopping mode (CHP of Filter Register = 1) and with the second filter included in the loop. The numbers are generated with a master clock frequency of 4.9152 MHz. These numbers are typical and generated at a differential analog input voltage of 0 V. The output update rate is selected via the SF0 to SF11 bits of the Filter Register. Table IV, meanwhile, shows the output peak-to-peak resolution in bits (rounded to the nearest 0.5 LSB) for the same output update rates. It is important to note that the numbers in Table IV represent the resolution for which there will be no code flicker within a six-sigma limit. They are not calculated based on rms noise but on peak-to-peak noise.

The numbers are generated for the bipolar input ranges. When the part is operated in unipolar mode, the output noise will be the same as the equivalent bipolar input range. As a result, the numbers in Table III will remain the same for unipolar ranges. To calculate the number for Table IV for unipolar input ranges simply subtract one from the peak-to-peak resolution number in bits.

Table III. Output Noise vs. Input Range and Update Rate (CHP = 1, SKIP = 0)

Typical Output RMS Noise in nV

Output	-3 dB	SF	Settlin	ettling Time Input Range							
Data Rate	Frequency	Word	Norm al	Fast Step	±1.28 V	±640 m V	±320 m V	±160 m V	±80 m V	±40 m V	±20 m V
50 Hz	1.97 Hz	2048	440 ms	40 ms	700	425	265	170	120	85	55
100 Hz	3.95 Hz	1024	220 ms	20 ms	980	550	330	230	190	115	90
150 Hz	5.92 Hz	683	147 ms	13.3 ms	1230	700	445	270	210	140	100
200 Hz	7.9 Hz	512	110 ms	10 ms	1260	840	500	340	245	170	105
400 Hz	15.8 Hz	256	55 ms	5 ms	2000	1230	690	430	335	215	160
800 Hz	31.6 Hz	128	27.5 ms	2.5 ms	3800	2100	1400	760	590	345	220

Table IV. Peak-to-Peak Resolution vs. Input Range and Update Rate (CHP = 1, SKIP = 0)

Peak-to-Peak Resolution in Bits

Output	-3 dB	SF	Settlir	ng Tim e			I	nput Rang	e		
Data Rate	Frequency	Word	Normal	Fast Step	±1.28 V	±640 mV	±320 m V	±160 m V	±80 m V	±40 mV	±20 m V
50 Hz	1.97 Hz	2048	440 ms	40 ms	19	19	18.5	18.5	18	17.5	17
100 Hz	3.95 Hz	1024	230 ms	30 ms	19	18.5	18.5	18	17	17	16
150 Hz	5.92 Hz	683	147 ms	13.3 ms	18.5	18	18	17.5	17	16.5	16
200 Hz	7.9 Hz	512	110 ms	10 ms	18.5	18	17.5	17.5	17	16.5	16
400 Hz	15.8 Hz	256	55 ms	5 ms	17.5	17.5	17	17	16.5	16	15.5
800 Hz	31.6 Hz	128	27.5 ms	2.5 ms	17	16.5	16	16	15.5	15	15

ON-CHIP REGISTERS

The AD7731 contains 12 on-chip registers that can be accessed via the serial port of the part. These registers are summarized in Figure 4 and in Table V, and described in detail in the following sections.

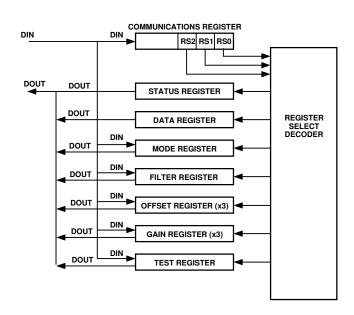


Figure 4. Register Overview

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Table V. Summary of On-Chip Registers

Register Name	Туре	Size	Power-On/Reset Default Value	Function
Communications Register	Write Only	8 Bits	Not Applicable	All operations to other registers are initiated through the Communications Register. This controls whether
WEN ZERO	RW1 RW0	ZERO RS	2 RS1 RS0	subsequent operations are read or write operations and also selects the register for that subsequent operation. Most subsequent operations return control to the Communications Register except for the continuous read mode of operation.
Status Register RDY STDY	Read Only STBY NOREF	8 Bits MS3 MS	CX Hex S2 MS1 MS0	Provides status information on conversions, calibrations, settling to step inputs, standby operation and the validity of the reference voltage.
Data Register	Read Only	16 Bits or 24	4 Bits 000000 Hex	Provides the most up-to-date conversion result from the part. Register length can be programmed to be 16 bit or 24 bit.
Mode Register MD2 MD1 HIREF RN2	Read/Write MD0 B/U RN1 RN0	DEN D BO CH		Controls functions such as mode of operation, uni- polar/bipolar operation, controlling the function of AIN 3/D 1 and AIN 4/D0, burnout current and Data Register word length. It also contains the reference selection bit, the range selection bits and the channel selection bits.
Filter Register SF11 SF10 SF3 SF2	Read/Write SF9 SF8 SF1 SF0	16 Bits SF7 SF6 ZERO CHF	2002 Hex SF5 SF4 SKIP FAST	Controls the amount of averaging in the first stage filter, selects the fast step and skip modes and con- trols the chopping modes on the part.
Offset Register	Read/Write	24 Bits		Contains a 24-bit word which is the offset calibration coefficient for the part. The contents of this register are used to provide offset correction on the output from the digital filter. There are three Offset Registers on the part and these are associated with input channel pairs as outlined in Table XIII.
Gain Register	Read/Write	24 Bits		Contains a 24-bit word which is the gain calibration coefficient for the part. The contents of this register are used to provide gain correction on the output from the digital filter. There are three Gain Registers on the part and these are associated with input channel pairs as outlined in Table XIII.
Test Register	Read/Write	24 Bits	000000 Hex	Controls the test modes of the part which are used when testing the part. The user is advised not to change the contents of this register.

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Communications Register (RS2-RS0 = 0, 0, 0)

The Communications Register is an 8-bit write-only register. All communications to the part must start with a write operation to the Communications Register. The data written to the Communications Register determines whether the next operation is a read or write operation, the type of read operation and to which register this operation takes place. For single-shot read or write operations, once the subsequent read or write operation to the selected register is complete, the interface returns to where it expects a write operation to the Communications Register. This is the default state of the interface, and on power-up or after a RESET, the AD7731 is in this default state waiting for a write operation to the Communications Register. In situations where the interface sequence is lost, a write operation of at least 32 serial clock cycles with DIN high, returns the AD7731 to this default state by resetting the part. Table VI outlines the bit designations for the Communications Register. CR0 through CR7 indicate the bit location, CR denoting the bits are in the Communications Register. CR7 denotes the first bit of the data stream.

Table VI. Communications Register

CR7	CR6	CR5	CR4	CR3	CR2	CR1	CR0
WEN	ZERO	RW1	RW0	ZERO	RS2	RS1	RS0

Bit Location	Bit Mnemonic	Description			
CR7 WEN		Write Enable Bit. A 0 must be written to this bit so the write operation to the Communications Register actually takes place. If a 1 is written to this bit, the part will not clock on to subsequent bits in the register. It will stay at this bit location until a 0 is written to this bit. Once a 0 is written to the WEN bit, the next seven bits will be loaded to the Communications Register.			
CR6	ZERO	A zero must be written to this bit to ensure correct operation of the AD7731.			
CR5, CR4	RW1, RW0	Read Write Mode Bits. These two bits determine the nature of the subsequent read/write operation. Table VII outlines the four options.			

Table VII. Read/Write Mode

RW1	RW0	Read/Write Mode
0	0	Single Write to Specified Register
0	1	Single Read of Specified Register
1	0	Start Continuous Read of Specified Register
1	1	Stop Continuous Read Mode

With 0, 0 written to these two bits, the next operation is a write operation to the register specified by bits RS2, RS1, RS0. Once the subsequent write operation to the specified register has been completed, the part returns to where it is expecting a write operation to the Communications Register.

With 0, 1 written to these two bits, the next operation is a read operation of the register specified by bits RS2, RS1, RS0. Once the subsequent read operation to the specified register has been completed, the part returns to where it is expecting a write operation to the Communications Register.

Writing 1, 0 to these bits, sets the part into a mode of continuous reads from the register specified by bits RS2, RS1, RS0. The most likely registers which the user will want to use this function with are the Data Register and the Status Register. Subsequent operations to the part will consist of read operations to the specified register without any intermediate writes to the Communications Register. This means that once the next read operation to the specified register has taken place, the part will be in a mode where it is expecting another read from that specified register. The part will remain in this continuous read mode until 30 Hex has been written to bits RW1 and RW0.

When 1, 1 is written to these bits (and 0 written to bits CR3 through CR0), the continuous read mode is stopped and the part returns to where it is expecting a write operation to the Communications Register. Note, the part continues to look at the DIN line on each SCLK edge during the continuous read mode so that it can determine when to stop the continuous read mode. Therefore, the user must be careful not to inadvertently exit the continuous read mode or reset the part by writing a series of 1s to the part. The easiest way to avoid this is to place a logic 0 on the DIN line while the part is in continuous read mode.

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Bit Location	Bit Mnemonic	Description
CR3	ZERO	A zero must be written to this bit to ensure correct operation of the AD7731.
CR2-CR0	RS2-RS0	Register Selection Bits. RS2 is the MSB of the three selection bits. The three bits select to which one of eight on-chip registers the next read or write operation takes place as shown in Table VIII.

Table VIII. Register Selection

RS2	RS1	RS0	Register
0	0	0	Communications Register (Write Operation)
0	0	0	Status Register (Read Operation)
)	0	1	Data Register
)	1	0	Mode Register
)	1	1	Filter Register
	0	0	No Register Access
1	0	1	Offset Register
1	1	0	Gain Register
l	1	1	Test Register

Status Register (RS2-RS0 = 0, 0, 0); Power-On/Reset Status: CX Hex

The Status Register is an 8-bit read-only register. To access the Status Register, the user must write to the Communications Register selecting either a single-shot read or continuous read mode and load bits RS2, RS1, RS0 with 0, 0, 0. Table IX outlines the bit designations for the Status Register. SR0 through SR7 indicate the bit location, SR denoting the bits are in the Status Register. SR7 denotes the first bit of the data stream. Figure 5 shows a flowchart for reading from the registers on the AD7731. The number in brackets indicates the power-on/reset default status of that bit.

Table IX. Status Register

SR7	SR6	SR5	SR4	SR3	SR2	SR1	SR0	
$\overline{\text{RDY}}$ (1)	$\overline{\text{STDY}}$ (1)	STBY (0)	NOREF (0)	MS3 (X)	MS2 (X)	MS1 (X)	MS0 (X)	

Bit Location	Bit Mnemonic	Description
SR7	RDY	Ready Bit. This bit provides the status of the \overline{RDY} flag from the part. The status and function of this bit is the same as the \overline{RDY} output pin. A number of events set the \overline{RDY} bit high as indicated in Table XVII.
SR6	STDY	Steady Bit. This bit is updated when the filter writes a result to the Data Register. If the filter is in $FAST$ Step TM mode (see Filter Register section), and responding to a step input, the \overline{STDY} bit remains high as the initial conversion results become available. The \overline{RDY} output and bit are set low on these initial conversions to indicate that a result is available. However, if the \overline{STDY} is high, it indicates that the result being provided is not from a fully settled second-stage FIR filter. When the FIR filter has fully settled, the \overline{STDY} bit will go low coincident with \overline{RDY} . If the part is never placed into its $FAST$ Step TM mode, the \overline{STDY} bit will go low at the first Data Register read and it is not cleared by subsequent Data Register reads. A number of events set the \overline{STDY} bit high as indicated in Table XVII. \overline{STDY} is set high along with \overline{RDY} by all events in the table except a Data Register read.
SR5	STBY	Standby Bit. This bit indicates whether the AD7731 is in its Standby Mode or normal mode of operation. The part can be placed in its standby mode using the STANDBY input pin or by writing 011 to the MD2 to MD0 bits of the Mode Register. The power-on/reset status of this bit is 0 assuming the STANDBY pin is high.
SR4	NOREF	No Reference Bit. If the voltage between the REF IN(+) and REF IN(-) pins is below 0.5 V or either of these inputs is open-circuit, the NOREF bit goes to 1. If NOREF is active on completion of a conversion, the Data Register is loaded with all 1s. If NOREF is active on completion of a calibration, updating of the calibration registers is inhibited.
SR3-SR0	MS3-MS0	These bits are for factory use. The power-on/reset status of these bits varies depending on the factory-assigned number.

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Data Register (RS2-RS0 = 0, 0, 1); Power On/Reset Status: 000000 Hex

The Data Register on the part is a read-only register that contains the most up-to-date conversion result from the AD7731. Figure 5 shows a flowchart for reading from the registers on the AD7731. The register can be programmed to be either 16 or 24 bits wide, determined by the status of the WL bit of the Mode Register. The \overline{RDY} output and \overline{RDY} bit of the Status Register are set low when the Data Register is updated. The \overline{RDY} pin and \overline{RDY} bit will return high once the full contents of the register (either 16 or 24 bits) have been read. If the Data Register has not been read by the time the next output update occurs, the \overline{RDY} pin and \overline{RDY} bit will go high for at least $158.5 \times t_{CLK~IN}$ indicating when a read from the Data Register should not be initiated to avoid a transfer from the Data Register as it is being updated. Once the updating of the Data Register has taken place, \overline{RDY} returns low.

If the Communications Register data sets up the part for a write operation to this register, a write operation must actually take place in order to return the part to where it is expecting a write operation to the Communications Register (the default state of the interface). However, the 16 or 24 bits of data written to the part will be ignored by the AD7731.

Mode Register (RS2-RS0 = 0, 1, 0); Power-On/Reset Status: 0174 Hex

The Mode Register is a 16-bit register from which data can either be read or to which data can be written. This register configures the operating modes of the AD7731, the input range selection, the channel selection and the word length of the Data Register. Table X outlines the bit designations for the Mode Register. MR0 through MR15 indicate the bit location, MR denoting the bits are in the Mode Register. MR15 denotes the first bit of the data stream. The number in brackets indicates the power-on/reset default status of that bit. Figure 5 shows a flowchart for reading from the registers on the AD7731 and Figure 6 shows a flowchart for writing to the registers on the part.

Table X. Mode Register

MR15	MR14	MR13	MR12	MR11	MR10	MR9	MR8
MD2 (0)	MD1 (0)	MD0 (0)	<u>B</u> /U (0)	DEN (0)	D1 (0)	D0 (0)	WL (1)
							·
MR7	MR6	MR5	MR4	MR3	MR2	MR1	MR0
HIREF (0)	RN2 (1)	RN1 (1)	RN0 (1)	BO (0)	CH2 (1)	CH1 (0)	CH0 (0)

Bit	Bit	
Location	Mnemonic	Description

MR15-MR13 MD2-MD0

Mode Bits. These three bits determine the mode of operation of the AD7731 as outlined in Table XI. The modes are independent, such that writing new mode bits to the Mode Register will exit the part from the mode in which it is operating and place it in the new requested mode immediately after the Mode Register write. The function of the mode bits is described in more detail below.

Table XI. Operating Modes

MD2	MD1	MD0	Mode of Operation	
0	0	0	Sync (Idle) Mode	Power-On/Reset Default
0	0	1	Continuous Conversion Mode	
0	1	0	Single Conversion Mode	
0	1	1	Power-Down (Standby) Mode	
1	0	0	Internal Zero-Scale Calibration	
1	0	1	Internal Full-Scale Calibration	
1	1	0	System Zero-Scale Calibration	
1	1	1	System Full-Scale Calibration	

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MD2	MD1	MD0	Operating Mode
0	0	0	Sync (Idle) Mode. In this mode, the modulator and filter are held in reset mode and the AD7731 is not processing any new samples or data. Placing the part in this mode is equivalent to exerting the SYNC input pin. However, exerting the SYNC does not actually force these mode bits to 0, 0, 0. The part returns to this mode after a calibration or after a conversion in Single Conversion Mode. This is the default condition of these bits after Power-On/Reset.
0	0	1	Continuous Conversion Mode. In this mode, the AD7731 is continuously processing data and providing conversion results to the Data Register at the programmed output update rate (as determined by the Filter Register). For most applications, this would be the normal operating mode of the AD7731.
0	1	0	Single Conversion Mode. In this mode, the AD7731 performs a single conversion, updates the Data Register, returns to the Sync Mode and resets the mode bits to 0, 0, 0. The result of the single conversion on the AD7731 in this mode will not be provided until the full settling-time of the filter has elapsed.
0	1	1	Power-Down (Standby) Mode. In this mode, the AD7731 goes into its power-down or standby state. Placing the part in this mode is equivalent to exerting the STANDBY input pin. However, exerting STANDBY does not actually force these mode bits to 0, 1, 1.
1	0	0	Zero-Scale Self-Calibration Mode. This activates zero-scale self-calibration on the channel selected by the CH2, CH1 and CH0 bits of the Mode Register. This zero-scale self-calibration is performed at the selected gain on internally shorted (zeroed) inputs. When this zero-scale self-calibration is complete, the part updates the contents of the Offset Calibration Register and returns to Sync Mode with MD2, MD1 and MD0 returning to 0, 0, 0. The RDY output and bit go high when calibration is initiated and return low when this zero-scale self-calibration is complete to indicate that the part is back in Sync Mode and ready for further operations.
1	0	1	Full-Scale Self-Calibration Mode. This activates full-scale self-calibration on the channel selected by the CH2, CH1 and CH0 bits of the Mode Register. This full-scale self-calibration is performed at the selected gain on an internally-generated full-scale signal. When this full-scale self-calibration is complete, the part updates the contents of the Gain Calibration Register and returns to Sync Mode with MD2, MD1 and MD0 returning to 0, 0, 0. The RDY output and bit go high when calibration is initiated and return low when this full-scale self-calibration is complete to indicate that the part is back in Sync Mode and ready for further operations.
1	1	0	Zero-Scale System Calibration Mode. This activates zero scale system calibration on the channel selected by the CH2, CH1 and CH0 bits of the Mode Register. Calibration is performed at the selected gain on the input voltage provided at the analog input during this calibration sequence. This input voltage should remain stable for the duration of the calibration. When this zero-scale system calibration is complete, the part updates the contents of the Offset Calibration Register and returns to Sync Mode with MD2, MD1 and MD0 returning to 0, 0, 0. The $\overline{\text{RDY}}$ output and bit go high when calibration is initiated and return low when this zero-scale calibration is complete to indicate that the part is back in Sync Mode and ready for further operations.
1	1	1	Full-Scale System Calibration Mode. This activates full-scale system calibration on the selected input channel. Calibration is performed at the selected gain on the input voltage provided at the analog input during this calibration sequence. This input voltage should remain stable for the duration of the calibration. When this full-scale system calibration is complete, the part updates the contents of the Gain Calibration Register and returns to Sync Mode with MD2, MD1 and MD0 returning to 0, 0, 0. The RDY output and bit go high when calibration is initiated and return low when this full-scale calibration is complete to indicate that the part is back in Sync Mode and ready for further operations.

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Bit	Bit	
Location	Mnemonic	Description
MR12	B̄/U	Bipolar/Unipolar Bit. A 0 in this bit selects bipolar operation and the output coding is 00000 for negative full-scale input, 10000 for zero input and 11111 for positive full-scale input. A 1 in this bit selects unipolar operation and the output coding is 00000 for zero input and 11111 for positive full-scale input.
MR11	DEN	Digital Output Enable Bit. With this bit at 1, the AIN3/D1 and AIN4/D0 pins assume their digital output functions and the output drivers connected to these pins are enabled. In this mode, the user effectively has two port bits which can be programmed over the serial interface.
MR10-MR9	D1-D0	Digital Output Bits. These bits determine the digital outputs on the AIN3/D1 and AIN4/D0 pins respectively when the DEN bit is a 1. For example, a 1 written to the D1 bit of the Mode Register (with the DEN bit also a 1) will put a logic 1 on the AIN3/D1 pin. This logic 1 will remain on this pin until a 0 is written to the D1 bit (in which case, the AIN3/D1 pin goes to a logic 0) or the digital output function is disabled by writing a 0 to the DEN bit.
MR8	WL	Data Word Length Bit. This bit determines the word length of the Data Register. A 0 in this bit selects 16-bit word length when reading from the data register (i.e., RDY returns high after 16 serial clock cycles in the read operation). A 1 in this bit selects 24-bit word length for the Data Register.
MR7	HIREF	High Reference Bit. This bit should be set in accordance with the reference voltage which is being used on the part. If the reference voltage is 2.5 V, the HIREF bit should be set to 0. If the reference voltage is 5 V, the HIREF bit should be set to a 1. With the HIREF bit set correctly for the appropriate applied reference voltage, the input ranges are 0 mV to +20 mV, +40 mV, +80 mV, +160 mV, +320 mV, +640 mV and +1.28 V for unipolar operation and ± 20 mV, ± 40 mV, ± 80 mV, ± 160 mV, ± 320 mV, ± 640 mV and ± 1.28 V for bipolar operation.
		It is possible for a user with a 2.5 V reference to set the HIREF bit to a 1. In this case, the part is operating with a 2.5 V reference but assumes it has a 5 V reference. As a result, the input ranges on the part become 0 mV to +10 mV through 0 mV to +640 mV for unipolar operation and ± 10 mV through ± 640 mV for bipolar operation. However, the output noise from the part (in nV) will remain unchanged so the resolution of the part (in LSBs) will reduce by 1.
MR6-MR4	RN2-RN0	Input Range Bits. These bits determine the analog input range for the selected analog input. The different input ranges are outlined in Table XII. The table is valid for a reference voltage of 2.5 V with the HIREF bit at 0 or for a reference voltage of 5 V with the HIREF bit at a logic 1.

Table XII. Input Range Selection

			Input Range					
RN2	RN1	RN0	$\overline{\mathbf{B}}/\mathbf{U}$ Bit = 0	$\overline{\mathbf{B}}/\mathbf{U}$ Bit = 1				
0	0	0	-20 mV to +20 mV	0 mV to +20 mV				
0	0	1	-20 mV to +20 mV	0 mV to +20 mV				
0	1	0	-40 mV to +40 mV	0 mV to +40 mV				
0	1	1	-80 mV to +80 mV	0 mV to +80 mV				
1	0	0	-160 mV to +160 mV	0 mV to +160 mV				
1	0	1	-320 mV to +320 mV	0 mV to +320 mV				
1	1	0	-640 mV to +640 mV	0 mV to +640 mV				
1	1	1	-1.28 V to +1.28 V	0 mV to +1.28 V Power-On/Reset Default				

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Bit Location	Bit Mnemonic	Description			
MR3	во	Burnout Current Bit. A 1 in this bit activates the burnout currents. When active, the burnout currents connect to the selected analog input pair, one source current to the AIN(+) input and one sink current to the AIN(-) input. A 0 in this bit turns off the on-chip burnout currents.			
MR2-MR0	CH2-CH0	Channel Select. These three bits select a channel either for conversion or for access to calibration coefficients as outlined in Table XIII. There are three pairs of calibration registers on the part. In fully differential mode, the part has three input channels so each channel has its own pair of calibration registers. In pseudo-differential mode, the AD7731 has five input channels with some of the input channel combinations sharing calibration registers. With CH2, CH1 and CH0 at a logic 1, the part looks at the AIN6 input internally shorted to itself. This can be used as a test method to evaluate the noise performance of the part with no external noise sources. In this mode, the AIN6 input should be connected to an external voltage within the allowable common-mode range for the part. The power-on/default status of these bits is 1, 0, 0.			

Table XIII. Channel Selection

CH2	CH1	СНО	AIN(+)	AIN(-)	Type	Calibration Register Pair
0	0	0	AIN 1	AIN 6	Pseudo Differential	Register Pair 0
0	0	1	AIN2	AIN6	Pseudo Differential	Register Pair 1
0	1	0	AIN3	AIN6	Pseudo Differential	Register Pair 2
0	1	1	AIN4	AIN 6	Pseudo Differential	Register Pair 2
1	0	0	AIN1	AIN 2	Fully Differential	Register Pair 0
1	0	1	AIN3	AIN4	Fully Differential	Register Pair 1
1	1	0	AIN5	AIN 6	Fully Differential	Register Pair 2
1	1	1	AIN6	AIN6	Test Mode	Register Pair 2

Filter Register (RS2-RS0 = 0, 1, 1); Power-On/Reset Status: 2002 Hex

The Filter Register is a 16-bit register from which data can either be read or to which data can be written. This register determines the amount of averaging performed by the filter and the mode of operation of the filter. It also sets the chopping mode. Table XIV outlines the bit designations for the Filter Register. FR0 through FR15 indicate the bit location, FR denoting the bits are in the Filter Register. FR15 denotes the first bit of the data stream. The number in brackets indicates the power-on/reset default status of that bit. Figure 5 shows a flowchart for reading from the registers on the AD7731 and Figure 6 shows a flowchart for writing to the registers on the part.

Table XIV. Filter Register

FR15	FR14	FR13	FR12	FR11	FR10	FR9	FR8
SF11 (0)	SF10 (0)	SF9 (1)	SF8 (0)	SF7 (0)	SF6 (0)	SF5 (0)	SF4 (0)
FR7	FR6	FR5	FR4	FR3	FR2	FR1	FR0
SF3 (0)	SF2 (0)	SF1 (0)	SF0 (0)	ZERO (0)	CHP (0)	SKIP (1)	FAST (0)

Bit	Bit	
Location	Mnemonic	Description
FR15-FR4	SF11–SF0	Sinc ³ Filter Selection Bits. The AD7731 contains two filters, a Sinc ³ filter and an FIR filter. The 12 bits programmed to SF11 through SF0 sets the amount of averaging which the Sinc ³ filter performs. As a result, the number programmed to these 12 bits affects the –3 dB frequency and output update rate from the part (see Filter Architecture section). The allowable range for SF words depends on whether the part is operated with CHP on or off and SKIP on or off. Table XV outlines the SF ranges for different setups.

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Table XV. SF Ranges

СНОР	SKIP SF Range		Output Update Rate Range (Assuming 4.9152 MHz Clock)		
0	0	2048 to 150	150 Hz to 2.048 kHz		
1	0	2048 to 75	50 Hz to 1.365 kHz		
0	1	2048 to 40	150 Hz to 7.6 kHz		
1	1	2048 to 20	50 Hz to 5.12 kHz		

Bit Location	Bit Mnemonic	Description
FR3	ZERO	A zero must be written to this bit to ensure correct operation of the AD7731.
FR2	СНР	Chop Enable Bit. This bit determines if the chopping mode on the part is enabled. A 1 in this bit location enables chopping on the part. When the chop mode is enabled, the part is effectively chopped at its input and output to remove all offset and offset drift errors on the part. If offset performance with time and temperature are important parameters in the design, it is recommended that the user enable chopping on the part.
FR1	SKIP	FIR Filter Skip Bit. With a 0 in this bit, the AD7731 performs two stages of filtering before shipping a result out of the filter. The first is a Sinc ³ filter followed by a 22-tap FIR filter. With a 1 in this bit, the FIR filter on the part is bypassed and the output of the Sinc ³ is fed directly as the output result of the AD7731's filter (see Filter Architecture for more details on the filter implementation).
FR0	FAST	FASTStep TM Mode Enable Bit. A 1 in this bit enables the FASTStep TM mode on the AD7731. In this mode, if a step change on the input is detected, the FIR calculation portion of the filter is suspended and replaced by a simple moving average on the output of the Sinc ³ filter. Initially, two outputs from the sinc ³ filter are used to calculate an AD7731 output. The number of sinc ³ outputs used to calculate the moving average output is increased (from 2 to 4 to 8 to 16) until the STDY bit goes low. When the FIR filter has fully settled after a step, the STDY bit will become active and the FIR filter is switched back into the processing loop (see Filter Architecture section for more details on the FASTStep TM mode).

Offset Calibration Register (RS2-RS0 = 1, 0, 1)

The AD7731 contains three 24-bit Offset Calibration Registers, labeled Offset Calibration Register 0 to Offset Calibration Register 2, to which data can be written and from which data can be read. The three registers are totally independent of each other such that in fully-differential mode there is an offset register for each of the input channels. This register is used in conjunction with the associated Gain Calibration Register to form a register pair. The calibration register pair used to scale the output of the filter is as outlined in Table XIII. To access the appropriate Offset Calibration Register the user should write first to the Mode Register setting up the appropriate address in the CH2 to CH0 bits.

The Offset Calibration Register is updated after an offset calibration routine (1, 0, 0 or 1, 1, 0 loaded to the MD2, MD1, MD0 bits of the Mode Register). During subsequent conversions, the contents of this register are subtracted from the filter output prior to gain scaling being performed on the word. Figure 5 shows a flowchart for reading from the registers on the AD7731 and Figure 6 shows a flowchart for writing to the registers on the part.

Gain Calibration Register (RS2-RS0 = 1, 1, 0)

The AD7731 contains three 24-bit Gain Calibration Registers to which data can be written and from which data can be read. The three registers are totally independent of each other such that in fully-differential mode there is a gain register for each of the input channels. This register is used in conjunction with the associated Offset Calibration Register to form a register pair which scale the output of the filter before it is loaded to the Data Register. These register pairs are associated with input channel pairs as outlined in Table XIII. To access the appropriate Gain Calibration Register the user should write first to the Mode Register setting up the appropriate address in the CH2 to CH0 bits.

The Gain Calibration Register is updated after a gain calibration routine (1, 0, 1 or 1, 1, 1 loaded to the MD2, MD1, MD0 bits of the Mode Register). During subsequent conversions, the contents of this register are used to scale the number which has already been offset corrected with the Offset Calibration Register contents. Figure 5 shows a flowchart for reading from the registers on the AD7731 and Figure 6 shows a flowchart for writing to the registers on the part.

Test Register (RS2-RS0 = 1, 1, 1); Power On/Reset Status: 000000Hex

The AD7731 contains a 24-bit Test Register to which data can be written and from which data can be read. The contents of this register are used in testing the device. The user is advised not to change the status of any of the bits in this register from the default (Power-On or \overline{RESET}) status of all 0s as the part will be placed in one of its test modes and will not operate correctly. If the part enters one of its test modes, exercising \overline{RESET} or writing 32 successive 1s to the part will exit the part from the mode and return all register contents to their power-on/reset status. Note, if the part is placed in one of its test modes, it may not be possible to read back the contents of the Test Register depending on the test mode which the part has been placed.

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READING FROM AND WRITING TO THE ON-CHIP REGISTERS

The AD7731 contains a total of twelve on-chip registers. These registers are all accessed over a three-wire interface. As a result, addressing of registers is via a write operation to the topmost register on the part, the Communications Register. Figure 5 shows a flowchart for reading from the different registers on the part summarizing the sequence and the words to be written to access each of the registers. Figure 6 gives a flowchart for writing to the different registers on the part, again summarizing the sequence and words to be written to the AD7731.

Register	Byte W (Hex)	Byte Y (Hex)	Byte Z (Hex)
Status Register	10	20	30
Data Register	11	21	30
Mode Register	12	22	30
Filter Register	13	N/A*	N/A*
Offset Register	15	N/A*	N/A*
Gain Register	16	N/A*	N/A*

^{*}N/A = Not Applicable. Continuous reads of these registers does not make sense as the register contents would remain the same since they are only changed by a write operation.

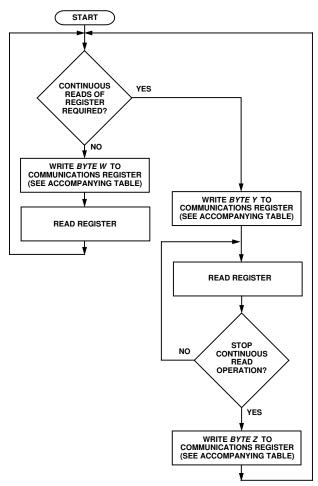


Figure 5. Flowchart for Reading from the AD7731 Registers

Register	Byte Y (Hex)
Communications Register	00
Data Register	Read Only Register.
Mode Register	02
Filter Register	03
Offset Register	05
Gain Register	06
Test Register	User is advised not
	to change contents of
	Test Register

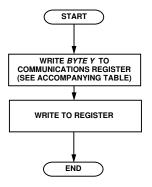


Figure 6. Flowchart for Writing to the AD7731 Registers

CALIBRATION OPERATION SUMMARY

The AD7731 contains a number of calibration options as outlined previously. Table XVI summarizes the calibration types, the operations involved and the duration of the operations. There are two methods of determining the end of calibration. The first is to monitor the hardware \overline{RDY} pin using either interrupt-driven or polling routines. The second method is to do a software poll of the \overline{RDY} bit in the Status Register. This can be achieved by setting up the part for continuous reads of the Status Register once a calibration has been initiated. The \overline{RDY} pin and \overline{RDY} bit go high on initiating a calibration and return low at the end of the calibration routine. At this time, the MD2, MD1, MD0 bits of the Mode Register have returned to 0, 0, 0. The FAST and SKIP bits are treated as 0 for the calibration sequence so the full filter is always used for the calibration routines. See Calibration section for full details.

Table XVI. Calibration Operations

				
Calibration Type	MD2, MD1, MD0	Duration to RDY Low (CHP = 1)	Duration to RDY Low (CHP = 0)	Calibration Sequence
Internal Zero-Scale	1, 0, 0	22 × 1/Output Rate	24 × 1/Output Rate	Calibration on internal shorted input with PGA set for selected input range. The Offset Calibration Register for the selected channel is updated at the end of this calibration sequence. For full self-calibration, this calibration should be preceded by an Internal Full-Scale calibration. For applications which require an Internal Zero-Scale and System Full Scale calibration, this Internal Zero-Scale calibration should be performed first.
Internal Full-Scale	1, 0, 1	44 × 1/Output Rate	48 × 1/Output Rate	Calibration on internally-generated input full-scale with PGA set for selected input range. The Gain Calibration Register for the selected channel is updated at the end of this calibration sequence. It is recommended that internal full-scale calibrations are performed on the operating input range except for the 20 mV and 40 mV input ranges where optimum results are achieved by calibrating on the 80 mV range. This calibration should be followed by either an Internal Zero-Scale or System Zero-Scale calibration. This calibration should be followed by either an Internal Zero-Scale or System Zero-Scale calibration. This zero-scale calibration should be performed at the operating input range.
System Zero-Scale	1, 1, 0	22 × 1/Output Rate	24 × 1/Output Rate	Calibration on externally-applied input voltage with PGA set for selected input range. The input applied is assumed to be the zero-scale of the system. For full system calibration, this System Zero-Scale calibration should be performed first. For applications which require a System Zero-Scale and Internal Full Scale calibration, this calibration should be preceded by the Internal Full-Scale calibration. The Offset Calibration Register for the selected channel is updated at the end of this calibration sequence.
System Full-Scale	1, 1, 1	22 × 1/Output Rate	24 × 1/Output Rate	Calibration on externally-applied input voltage with PGA set for selected input range. The input applied is assumed to be the full-scale of the system. This calibration should be preceded by a System Zero-Scale or Internal Zero-Scale calibration. The Gain Calibration Register for the selected channel is updated at the end of this calibration sequence.

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CIRCUIT DESCRIPTION

The AD7731 is a sigma-delta A/D converter with on-chip digital filtering, intended for the measurement of wide dynamic range, low-frequency signals such as those in strain-gage, pressure transducer, temperature measurement, industrial control or process control applications. It contains a sigma-delta (or charge-balancing) ADC, a calibration microcontroller with on-chip static RAM, a clock oscillator, a digital filter and a bidirectional serial communications port. The part consumes 13.5 mA of power supply current with a standby mode which consumes only 20 μA . The part operates from a single +5 V supply. The clock source for the part can be provided via an external clock or by connecting a crystal oscillator or ceramic resonator across the MCLK IN or MCLK OUT pins.

The part contains three programmable-gain fully differential analog input channels which can be reconfigured as five pseudo-differential inputs. The part handles a total of seven different input ranges on all channels which are programmed via the on-chip registers. The differential unipolar ranges are: 0 mV to $+20\ mV$ through 0 V to $+1.28\ V$ and the differential bipolar ranges are: $\pm20\ mV$ through $\pm1.28\ V$.

The AD7731 employs a sigma-delta conversion technique to realize up to 24 bits of no missing codes performance. The

sigma-delta modulator converts the sampled input signal into a digital pulse train whose duty cycle contains the digital information. A digital low-pass filter processes the output of the sigma-delta modulator and updates the data register at a rate that can be programmed over the serial interface. The output data from the part is accessed over this serial interface. The cutoff frequency and output rate of this filter can be programmed via on-chip registers. The output noise performance and peak-to-peak resolution of the part varies with gain and with the output rate as shown in Tables I to IV.

The analog inputs are buffered on-chip, allowing the part to handle significant source impedances on the analog input. This means that external R, C filtering (for noise rejection or RFI interference reduction) can be placed on the analog inputs if required. The common-mode voltage range for the analog inputs comes within 1.2 V of AGND and 0.95 V of AV_{DD} . The reference input is also differential and the common-mode range here is from AGND to AV_{DD} .

The AD7731 contains a number of hardware and software events that set or reset status flags and bits in registers. Table XVII summarizes which blocks and flags are affected by the different events.

Table XVII. Reset Events

Event	Set Registers to Default	Mode Bits	Filter Reset	Analog Power-Down	Reset Serial Interface	Set RDY Pin/Bit	Set STDY Bit
Power-On Reset	Yes	000	Yes	Yes	Yes	Yes	Yes
RESET Pin	Yes	000	Yes	No	Yes	Yes	Yes
STANDBY Pin	No	As Is	Yes	Yes	No	Yes	Yes
Mode 011 Write	No	011	Yes	Yes	No	Yes	Yes
SYNC Pin	No	As Is	Yes	No	No	Yes	Yes
Mode 000 Write	No	000	Yes	No	No	Yes	Yes
Conversion or	No	New	Initial	No	No	Yes	Yes
Cal Mode Write		Value	Reset				
Clock 32 1s	No	As Is	No	No	Yes	Yes	Yes
Data Register Read	No	As Is	No	No	No	Yes	No

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ANALOG INPUT

Analog Input Channels

The AD7731 has six analog input pins (labelled AIN1 to AIN6) which can be configured as either three fully differential input channels or five pseudo-differential input channels. Bits CH0, CH1 and CH2 of the Mode Register configure the input channel arrangement and the channel selection is as outlined previously in Table XIII. The input pairs (either differential or pseudo-differential) provide programmable-gain, input channels which can handle either unipolar or bipolar input signals. It should be noted that the bipolar input signals are referenced to the respective AIN(-) input of the input pair. The AIN3 and AIN4 pins can also be reconfigured as two digital output port bits, also controlled by the Mode Register.

A differential multiplexer switches one of the two input channels to the on-chip buffer amplifier. When the analog input channel is switched, the \overline{RDY} output goes high and the settling time of the part must elapse before a valid word from the new channel is available in the Data Register (indicated by \overline{RDY} going low).

Buffered Inputs

The output of the multiplexer feeds into a high impedance input stage of the buffer amplifier. As a result, the analog inputs can handle significant source impedances. This buffer amplifier has an input bias current of 50 nA (CHP = 1) and 60 nA (CHP = 0). This current flows in each leg of the analog input pair. The offset current on the part is the difference between the input bias on the legs of the input pair. This offset current is less than 10 nA (CHP = 1) and 25 nA (CHP = 0). Large source resistances result in a dc offset voltage developed across the source resistance on each leg but matched impedances on the analog input legs will reduce the offset voltage to that generated by the input offset current.

Analog Input Ranges

The absolute input voltage range is restricted to between AGND + 1.2~V to $AV_{\rm DD}-0.95~V$ which also places restrictions on the common-mode range. Care must be taken in setting up the common-mode voltage and input voltage range so that these limits are not exceeded, otherwise there will be a degradation in linearity performance.

In some applications, the analog input range may be biased either around system ground or slightly below system ground. In such cases, the AGND of the AD7731 must be biased negative with respect to system ground such that the analog input voltage does not go within 1.2 V of AGND. Care should taken to ensure that the differential between either $AV_{\rm DD}$ or $D\,V_{\rm DD}$ and this biased AGND does not exceed 5.5 V. This is discussed in more detail in the Applications section.

Program mable Gain Amplifier

The output from the buffer amplifier is applied to the input of the on-chip programmable gain amplifier (PGA). The PGA can handle seven different unipolar input ranges and seven bipolar ranges. With the HIREF bit of the Mode Register at 0 and a +2.5 V reference (or the HIREF bit at 1 and a +5 V reference), the unipolar ranges are 0 mV to +20 mV, 0 mV to +40 mV,

0 mV to +80 mV, 0 mV to +160 mV, 0 mV to +320 mV, 0 mV to +640 mV and 0 V to +1.28 V while the bipolar ranges are ± 20 mV, ± 40 mV, ± 80 mV, ± 160 mV, ± 320 mV, ± 640 mV, ± 1.28 V. These are the nominal ranges which should appear at the input to the on-chip PGA.

Bipolar/Unipolar Inputs

The analog inputs on the AD7731 can accept either unipolar or bipolar input voltage ranges. Bipolar input ranges do not imply that the part can handle negative voltages with respect to system ground on its analog inputs unless the AGND of the part is also biased below system ground. Unipolar and bipolar signals on the AIN(+) input are referenced to the voltage on the respective AIN(-) input. For example, if AIN(-) is +2.5 V and the AD7731 is configured for an analog input range of 0 mV to +20 mV, the input voltage range on the AIN(+) input is +2.5 V to +2.52 V. If AIN(-) is +2.5 V and the AD7731 is configured for an analog input range of ± 1.28 V, the analog input range on the AIN(+) input is +1.22 V to +3.78 V (i.e., 2.5 V \pm 1.28 V).

Bipolar or unipolar options are chosen by programming the \overline{B}/U bit of the Mode Register. This programs the selected channel for either unipolar or bipolar operation. Programming the channel for either unipolar or bipolar operation does not change any of the input signal conditioning; it simply changes the data output coding and the points on the transfer function where calibrations occur. When the AD7731 is configured for unipolar operation, the output coding is natural (straight) binary with a zero differential voltage resulting in a code of 100...000 and a full-scale input voltage resulting in a code of 111...111. When the AD7731 is configured for bipolar operation, the coding is offset binary with a negative full-scale voltage resulting in a code of 100...000 and a positive full-scale voltage resulting in a code of 100...000 and a positive full-scale voltage resulting in a code of 111...111.

Burnout Currents

The AD7731 contains two 100 nA constant current generators, one source current from AV_{DD} to AIN(+) and one sink from AIN1(-) to AGND. The currents are switched to the selected analog input pair. Both currents are either on or off depending on the BO bit of the Mode Register. These currents can be used in checking that a transducer is still operational before attempting to take measurements on that channel. If the currents are turned on, allowed flow in the transducer, a measurement of the input voltage on the analog input taken and the voltage measured is full scale then it indicates that the transducer has gone open-circuit. If the voltage measured is 0 V, it indicates that the transducer has gone open-circuit. For normal operation, these burnout currents are turned off by writing a 0 to the BO bit. The current sources work over the normal absolute input voltage range specifications.

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REFERENCE INPUT

The AD7731's reference inputs, REF IN(+) and REF IN(-), provide a differential reference input capability. The common-mode range for these differential inputs is from AGND to AV_{DD}. The nominal reference voltage, V_{REF} (REF IN(+) – REF IN(-)), for specified operation is +2.5 V with the HIREF bit at 0 and +5 V with the HIREF bit at 1. The part is also functional with V_{REF} of +2.5 V with the HIREF bit at 1. This results in a halving of all input ranges. The resolution in nV will be unaltered, but will be reduced by 1 bit in terms of peak-to-peak resolution.

Both reference inputs provide a high impedance, dynamic load. The typical average dc input leakage current is over temperature is 4.5 μ A with HIREF = 0 and 8 μ A with HIREF = 1. Because the input impedance on each reference input is dynamic, external resistance/capacitance combinations may result in gain errors on the part.

The output noise performance outlined in Tables I through IV is for an analog input of 0 V and is unaffected by noise on the reference. To obtain the same noise performance as shown in the noise tables over the full input range requires a low noise reference source for the AD7731. If the reference noise in the bandwidth of interest is excessive, it will degrade the performance of the AD7731. In applications where the excitation voltage for the transducer on the analog input also drives the reference voltage for the part, the effect of the low-frequency noise in the excitation voltage will be removed as the application is ratiometric. In this case, the reference voltage for the AD7731 and the excitation voltage for the transducer are the same. The HIREF bit of the Mode Register should be set to 1.

If the AD7731 is not used in a ratiometric application, a low noise reference should be used. Recommended reference voltage sources for the AD7731 include the AD780, REF43 and REF192. If any of these references are used as the reference source for the AD7731, the HIREF bit should be set to 0. It is generally recommended to decouple the output of these references to further reduce the noise level.

Reference Detect

The AD7731 includes on-chip circuitry to detect if the part has a valid reference for conversions or calibrations. If the voltage between the REF IN(+) and REF IN(-) pins goes below 0.3 V or either the REF IN(+) or REF IN(-) inputs is open circuit, the AD7731 detects that it no longer has a valid reference. In this case, the NOREF bit of the Status Register is set to a 1.

If the AD7731 is performing normal conversions and the NOREF bit becomes active, the part places all 1s in the Data Register. Therefore, it is not necessary to continuously monitor the status of the NOREF bit when performing conversions. It is only necessary to verify its status if the conversion result read from the Data Register is all 1s.

If the AD7731 is performing either an offset or gain calibration and the NOREF bit becomes active, the updating of the respective calibration register is inhibited to avoid loading incorrect coefficients to this register. If the user is concerned about verifying that a valid reference is in place every time a calibration is performed, then the status of the NOREF bit should be checked at the end of the calibration cycle.

SIGMA-DELTA MODULATOR

A sigma-delta ADC generally consists of two main blocks, an analog modulator and a digital filter. In the case of the AD7731, the analog modulator consists of a difference amplifier, an integrator block, a comparator and a feedback DAC as illustrated in Figure 7. In operation, the analog signal sample is fed to the difference amplifier along with the output of the feedback DAC. The difference between these two signals is integrated and fed to the comparator. The output of the comparator provides the input to the feedback DAC so the system functions as a negative feedback loop that tries to minimize the difference signal. The digital data that represents the analog input voltage is contained in the duty cycle of the pulse train appearing at the output of the comparator. This duty cycle data can be recovered as a data word using the digital filter. The sampling frequency of the modulator loop is many times higher than the bandwidth of the input signal. The integrator in the modulator shapes the quantization noise (which results from the analog to digital conversion) so that the noise is pushed towards one half of the modulator frequency. The digital filter then bandlimits the response to a frequency significantly lower than one half of the modulator frequency. In this manner, the 1-bit output of the comparator is translated into a bandlimited, low noise output from the AD7731.

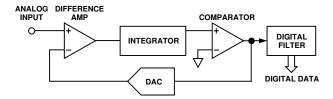


Figure 7. Sigma-Delta Modulator Block Diagram

DIGITAL FILTERING

Filter Architecture

The output of the modulator feeds directly into the digital filter. This digital filter consists of two portions, a first stage filter and a second stage filter. The cutoff frequency and output rate of the filter are programmable. The first stage filter is a low-pass, $sinc^3$ or $(sinx/x)^3$ filter whose primary function is to remove the quantization noise introduced at the modulator. The second stage filter has three distinct modes of operation. The first option is where it is bypassed completely such that the only filtering provided on the AD7731 is performed by the first stage sinc³ filter. The second is where it provides a low-pass 22-tap FIR filter which processes the output of the first stage filter. The third option is to enable FASTStepTM mode. In this mode, when a step change is detected on the analog input or the analog input channel switched, the second stage filter enters a mode where it performs a variable number of averages for some time after the step change and then the second stage filter switches back to the FIR filter.

The AD7731 has two primary modes of operation, chop mode (CHP = 1) and nonchop mode (CHP = 0). The AD7731 alternatively reverses its inputs with CHP = 1, and alternate outputs from the first stage filter have a positive offset and negative offset term included. With CHP = 0, the input is never reversed and the output of the first stage filter includes an offset which is always of the same polarity.

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